

3.3V Low Power EIA/TIA-562 3-Driver/ 5-Receiver Transceiver

FEATURES

- **Low Supply Current: 300 μ A**
- **Receivers 4 and 5 Kept Alive in Shutdown: 35 μ A**
- **ESD Protection: ± 10 kV**
- **Operates from a Single 3.3V Supply**
- **Uses Small Capacitors: 0.1 μ F**
- **Operates to 120kBaud**
- **Three-State Outputs are High Impedance When Off**
- **Output Overvoltage Does Not Force Current Back into Supplies**
- **EIA/TIA-562 I/O Lines Can Be Forced to ± 25 V Without Damage**
- **Flowthrough Architecture**

APPLICATIONS

- Notebook Computers
- Palmtop Computers

DESCRIPTION

The LTC[®]1350 is a 3-driver/5-receiver EIA/TIA-562 transceiver with very low supply current. In the no load condition, the supply current is only 300 μ A. The charge pump only requires four 0.1 μ F capacitors.

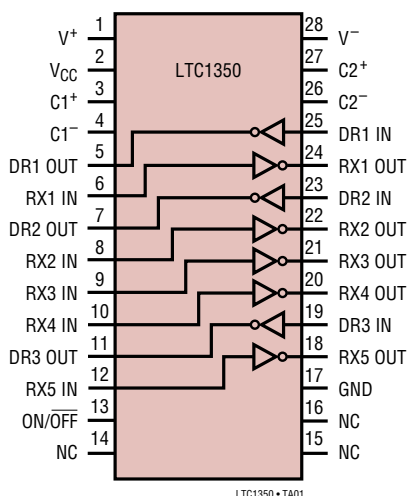
In Shutdown mode, two receivers are kept alive and the supply current is only 35 μ A. All RS232 outputs assume a high impedance state in Shutdown or with the power off.

The LTC1350 is fully compliant with all data rate and overvoltage EIA/TIA-562 specifications. The transceiver can operate up to 120kbaud with a 1000pF and 3k Ω load. Both driver outputs and receiver inputs can be forced to ± 25 V without damage and can survive multiple ± 10 kV ESD strikes.

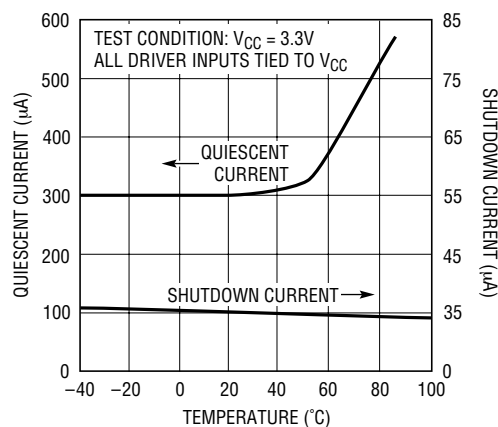
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TYPICAL APPLICATION

3-Drivers/5-Receivers with Shutdown



Quiescent and Shutdown Supply Current vs Temperature



LTC1350 • TA02

ABSOLUTE MAXIMUM RATINGS

Supply Voltage (V_{CC})	5V
Input Voltage	
Driver	$-0.3V$ to $V_{CC} + 0.3V$
Receiver	$-25V$ to $25V$
ON/OFF Pin	$-0.3V$ to $V_{CC} + 0.3V$
Output Voltage	
Driver	$-25V$ to $25V$
Receiver	$-0.3V$ to $V_{CC} + 0.3V$
Short-Circuit Duration	
V^+	30 sec
V^-	30 sec
Driver Output	Indefinite
Receiver Output	Indefinite
Operating Temperature Range	
Commercial (LTC1350C)	$0^{\circ}C$ to $70^{\circ}C$
Industrial (LTC1350I)	$-40^{\circ}C$ to $85^{\circ}C$
Storage Temperature Range	$-65^{\circ}C$ to $150^{\circ}C$
Lead Temperature (Soldering, 10 sec)	$300^{\circ}C$

PACKAGE/ORDER INFORMATION

TOP VIEW		ORDER PART NUMBER
G PACKAGE 28-LEAD SSOP NW PACKAGE 28-LEAD PDIP SW PACKAGE 28-LEAD PLASTIC SO WIDE		LTC1350CG LTC1350CNW LTC1350CSW LTC1350IG LTC1350INW LTC1350ISW

Consult LTC Marketing for parts specified with wider operating temperature ranges.

DC ELECTRICAL CHARACTERISTICS

The ● denotes specifications which apply over the full operating temperature range. $V_{CC} = 3.3V$, $C1 = C2 = C3 = C4 = 0.1\mu F$, unless noted.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Any Driver					
Output Voltage Swing	3k to GND Positive Negative	● 3.7	4.5		V
		● -3.7	-4.5		V
Logic Input Voltage Level	Input Low Level ($V_{OUT} = \text{High}$)	●	1.4	0.8	V
	Input High Level ($V_{OUT} = \text{Low}$)	● 2.0	1.4		V
Logic Input Current	$V_{IN} = V_{CC}$	●		5	μA
	$V_{IN} = 0V$	●		-5	μA
Output Short-Circuit Current	$V_{OUT} = 0V$		± 9	± 10	mA
Output Leakage Current	Shutdown (Note 3), $V_{OUT} = \pm 20V$		10	500	μA
Any Receiver					
Input Voltage Thresholds	Input Low Threshold	● 0.8	1.3		V
	Input High Threshold	●	1.7	2.4	V
Hysteresis		● 0.1	0.4	1	V
Input Resistance	$V_{IN} = \pm 10V$		3	5	k Ω
Output Voltage	Output Low, $I_{OUT} = -1.6mA$ ($V_{CC} = 3.3V$)	●	0.2	0.4	V
	Output High, $I_{OUT} = 160\mu A$ ($V_{CC} = 3.3V$)	● 3.0	3.2		V
Output Short-Circuit Current	Sinking Current, $V_{OUT} = V_{CC}$		-3	-20	mA
Output Leakage Current	Shutdown (Note 3), $0V \leq V_{OUT} \leq V_{CC}$	●	1	10	μA

DC ELECTRICAL CHARACTERISTICS

The ● denotes specifications which apply over the full operating temperature range. $V_{CC} = 3.3V$, $C1 = C2 = C3 = C4 = 0.1\mu F$, unless noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Power Supply Generator						
V^+ Output Voltage	$I_{OUT} = 0mA$			5.7		V
	$I_{OUT} = 5mA$			5.5		V
V^- Output Voltage	$I_{OUT} = 0mA$			-5.3		V
	$I_{OUT} = -5mA$			-5.0		V
Supply Rise Time	Shutdown to Turn-On			0.2		ms
Power Supply						
V_{CC} Supply Current	No Load (All Drivers $V_{IN} = V_{CC}$)(Note 2) $0^\circ C \leq T_A \leq 70^\circ C$	●		0.3	0.6	mA
	No Load (All Drivers $V_{IN} = 0$)(Note 2) $0^\circ C \leq T_A \leq 70^\circ C$	●		0.5	1.0	mA
	No Load (All Drivers $V_{IN} = V_{CC}$)(Note 2) $0^\circ C \leq T_A \leq 85^\circ C$	●		0.3	1.0	mA
	No Load (All Drivers $V_{IN} = V_{CC}$)(Note 2) $-40^\circ C \leq T_A \leq 0^\circ C$	●		0.3	1.5	mA
	No Load (All Drivers $V_{IN} = 0$)(Note 2) $-40^\circ C \leq T_A \leq 85^\circ C$	●		0.5	1.5	mA
	Shutdown (Note 3)	●		35	50	μA
ON/OFF Threshold Low		●		1.4	0.8	V
ON/OFF Threshold High		●	2.0	1.4		V

AC CHARACTERISTICS

The ● denotes specifications which apply over the full operating temperature range. $V_{CC} = 5V$, $C1 = C2 = C3 = C4 = 0.1\mu F$, unless noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Slew Rate	$R_L = 3k, C_L = 51pF$			8	30	V/ μs
	$R_L = 3k, C_L = 1000pF$		3	5		V/ μs
Driver Propagation Delay (TTL to EIA/TIA-562)	t_{HLD} (Figure 1)	●		2	3.5	μs
	t_{LHD} (Figure 1)	●		2	3.5	μs
Receiver Propagation Delay (EIA/TIA-562 to TTL)	t_{HLR} (Figure 2)	●		0.3	0.8	μs
	t_{LHR} (Figure 2)	●		0.3	0.8	μs

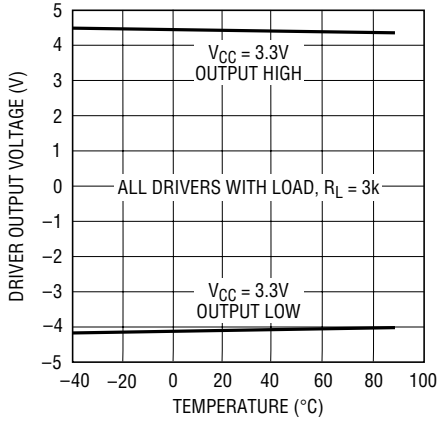
Note 1: Absolute Maximum Ratings are those values beyond which the life of the device may be impaired.

Note 2: Supply current is measured with driver and receiver outputs unloaded.

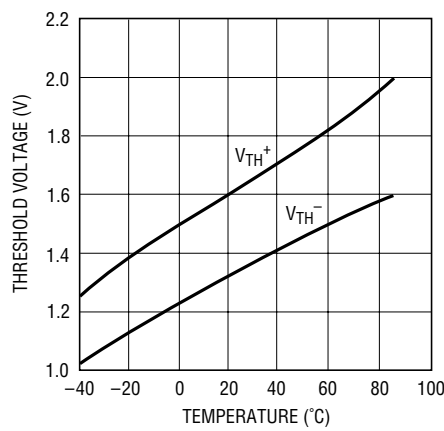
Note 3: Supply current measurement in Shutdown mode is performed with $V_{ON/OFF} = 0V$.

TYPICAL PERFORMANCE CHARACTERISTICS

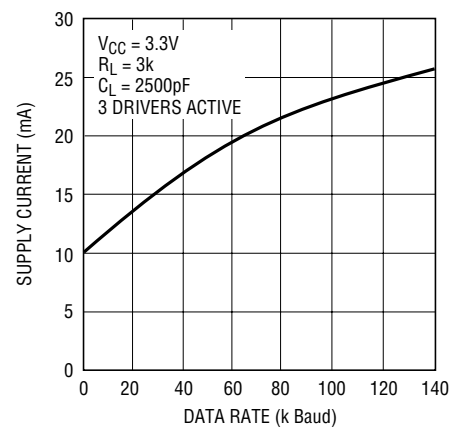
Driver Output Voltage vs Temperature



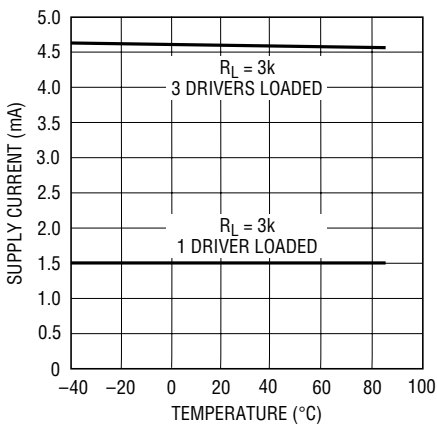
Receiver Input Thresholds vs Temperature



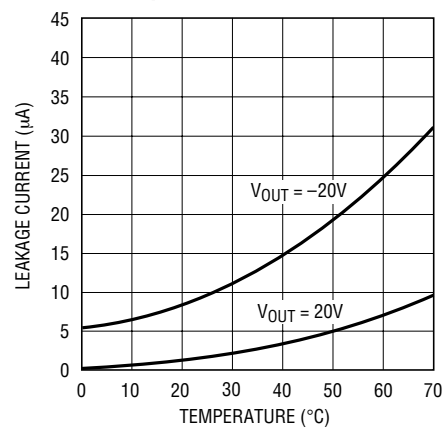
Supply Current vs Data Rate



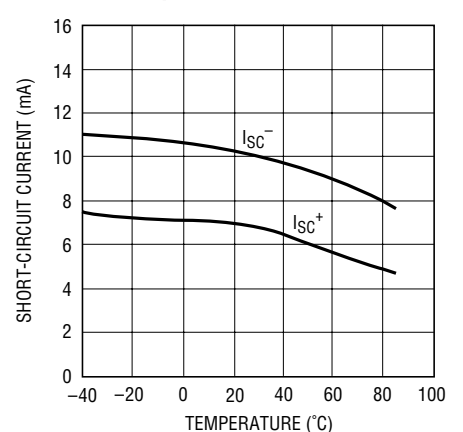
VCC Supply Current vs Temperature



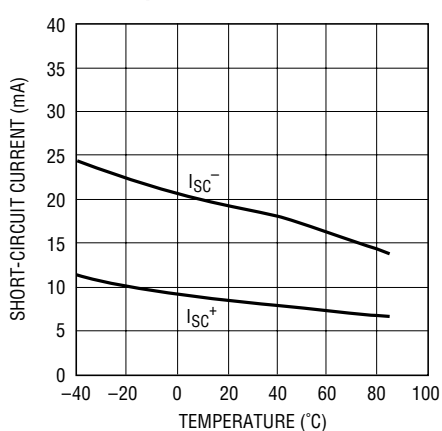
Driver Leakage in Shutdown vs Temperature



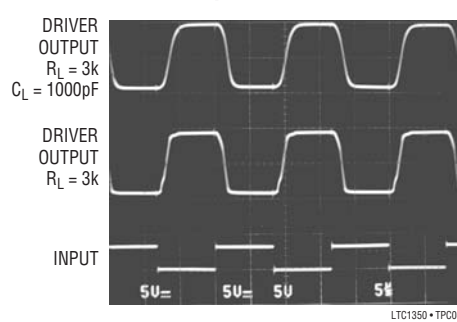
Driver Short-Circuit Current vs Temperature



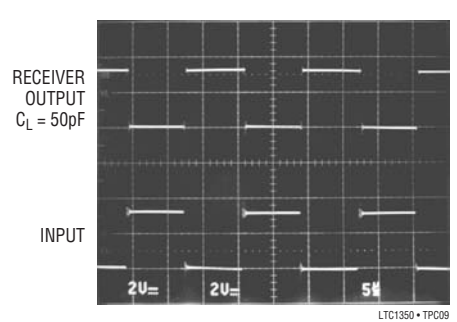
Receiver Short-Circuit Current vs Temperature



Driver Output Waveforms



Receiver Output Waveform



PIN FUNCTIONS

V_{CC}: 3.3V Input Supply Pin. Supply current is typically 35 μ A in the Shutdown mode. This pin should be decoupled with a 0.1 μ F ceramic capacitor.

GND: Ground Pin.

ON/OFF: TTL/CMOS Compatible Shutdown Pin. A logic low puts the device in the Shutdown mode with receivers 4 and 5 kept alive and the supply current equal to 35 μ A. All driver and other receiver outputs are in high impedance state. This pin cannot float.

V⁺: Positive Supply Output. $V^+ \cong 2V_{CC} - 1V$. This pin requires an external capacitor ($C = 0.1\mu F$) for charge storage. The capacitor may be tied to ground or V_{CC} . With multiple devices, the V^+ and V^- pins may be paralleled into common capacitors. For a large number of devices, increasing the size of the shared common storage capacitors is recommended to reduce ripple.

V⁻: Negative Supply Output. $V^- \cong -(2V_{CC} - 1.3V)$. This pin requires an external capacitor ($C = 0.1\mu F$) for charge storage.

C1⁺, C1⁻, C2⁺, C2⁻: Commutating Capacitor Inputs. These pins require two external capacitors ($C = 0.1\mu F$): one from C1⁺ to C1⁻ and another from C2⁺ to C2⁻. To maintain charge pump efficiency, the capacitor's effective series resistance should be less than 20 Ω .

DR IN: EIA/TIA-562 Driver Input Pins. Inputs are TTL/CMOS compatible. Inputs should not be allowed to float. Tie unused inputs to V_{CC} .

DR OUT: Driver Outputs at EIA/TIA-562 Voltage Levels. Outputs are in a high impedance state when in the Shutdown mode or $V_{CC} = 0V$. The driver outputs are protected against ESD to $\pm 10kV$ for human body model discharges.

RX IN: Receiver Inputs. These pins can be forced to $\pm 25V$ without damage. The receiver inputs are protected against ESD to $\pm 10kV$ for human body model discharges. Each receiver provides 0.4V of hysteresis for noise immunity.

RX OUT: Receiver Outputs with TTL/CMOS Voltage Levels. Receiver 1, 2 and 3 outputs are in a high impedance state when in Shutdown mode to allow data line sharing. Receivers 4 and 5 are kept alive in Shutdown.

SWITCHING TIME WAVEFORMS

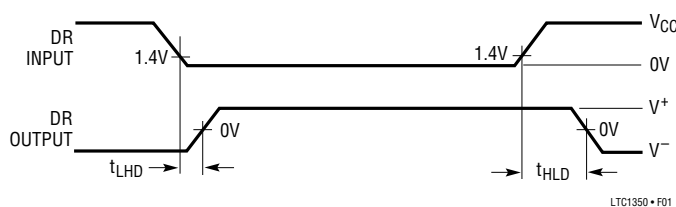


Figure 1. Driver Propagation Delay Timing

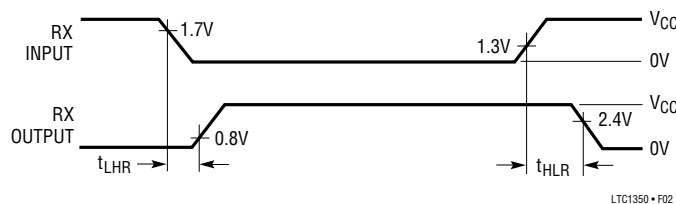
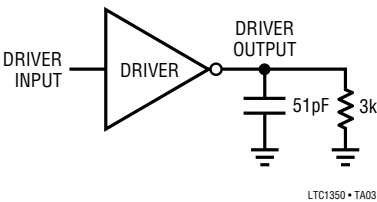


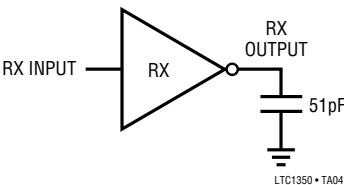
Figure 2. Receiver Propagation Delay Timing

TEST CIRCUITS

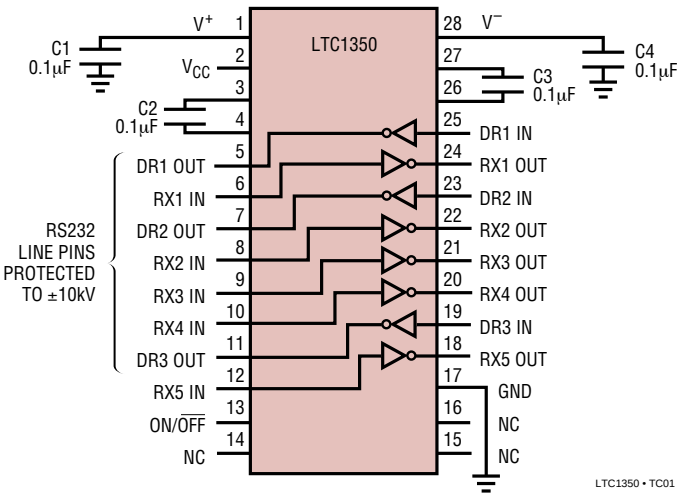
Driver Timing Test Load



Receiver Timing Test Load

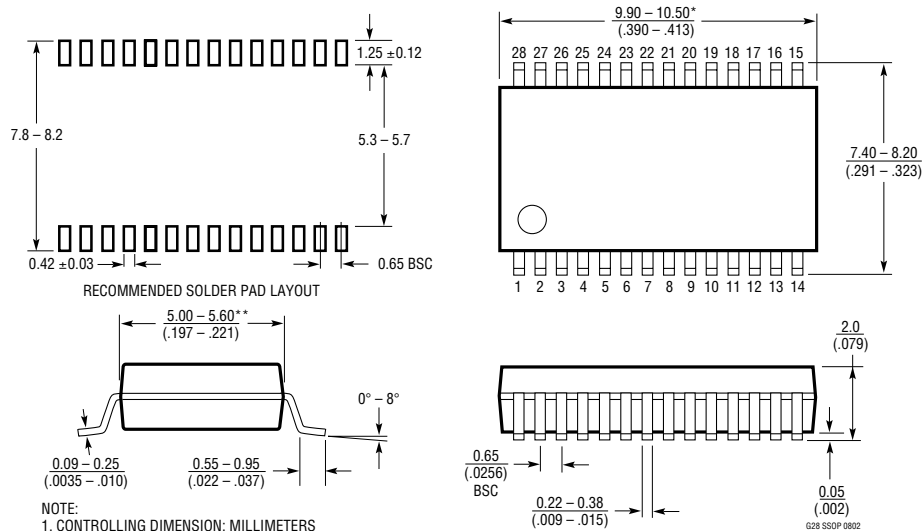


ESD Test Circuit

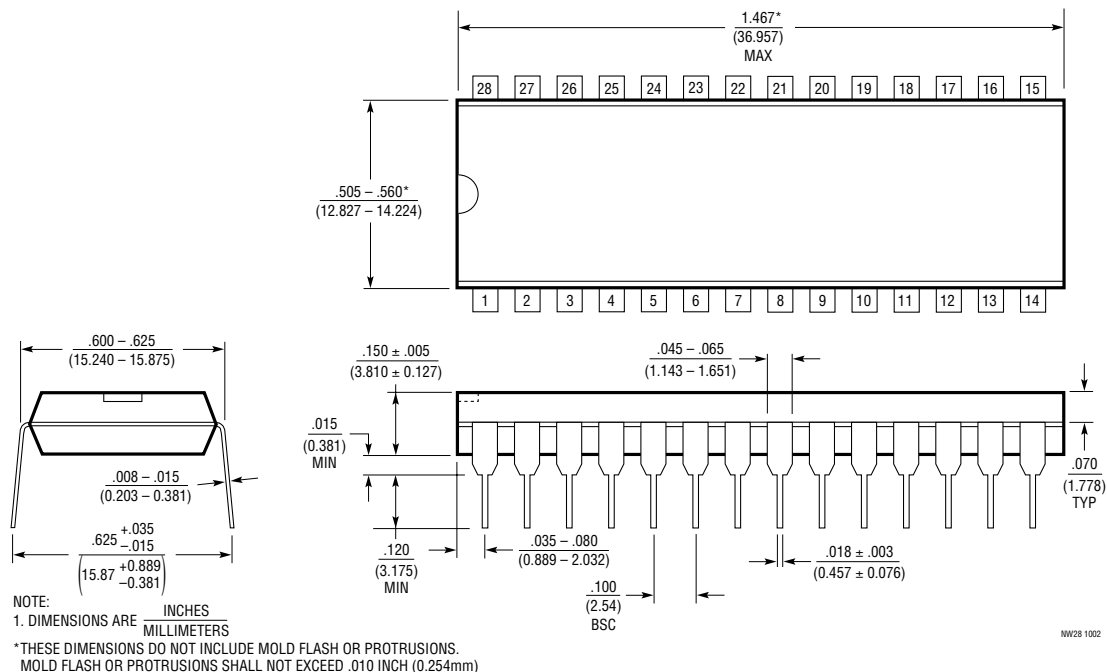


PACKAGE DESCRIPTION

G Package 28-Lead Plastic SSOP (5.3mm) (Reference LTC DWG # 05-08-1640)



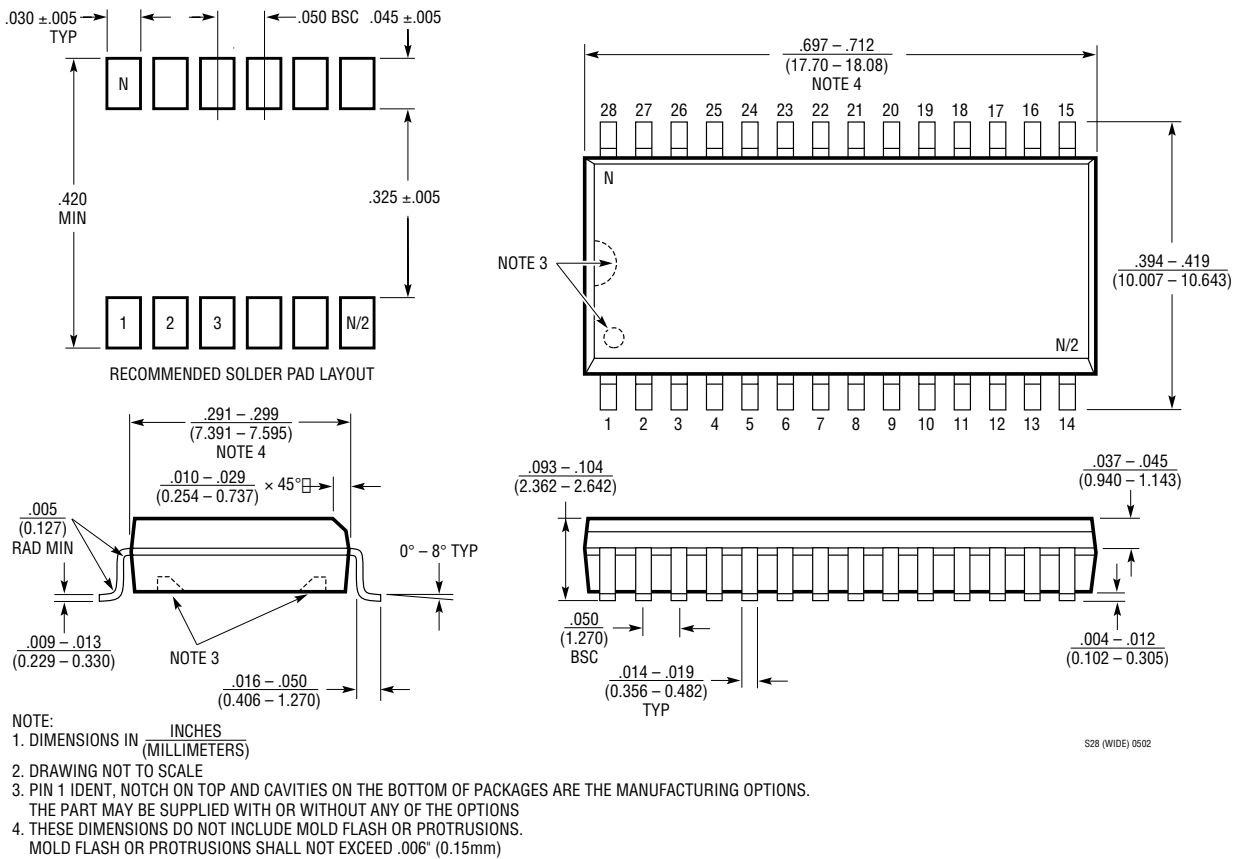
NW Package 28-Lead PDIP (Wide .600 Inch) (Reference LTC DWG # 05-08-1520)



NW28 1002

PACKAGE DESCRIPTION

SW Package 28-Lead Plastic Small Outline (Wide .300 Inch) (Reference LTC DWG # 05-08-1620)



S28 (WIDE) 0502

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT [®] 1137A	5V, 3 Driver, 5 Receiver RS232 Transceiver	±15kV ESD per IEC 1000-4
LTC1327	3.3V, 3 Driver, 5 Receiver RS562 Transceiver	300μA Supply Current, 0.2μA in Shutdown
LTC1337	5V, 3 Driver, 5 Receiver RS232 Transceiver	300μA Supply Current, 1μA in Shutdown
LTC1348	3.3V to 5V, 3 Driver, 5 Receiver RS232 Transceiver	True RS232 on 3.3V, 5 Receivers Active in Shutdown
LTC1385	3.3V, 2 Driver, 2 Receiver RS562 Transceiver	200μA Supply Current, 2 Receivers Active in Shutdown
LTC1386	3.3V, 2 Driver, 2 Receiver RS562 Transceiver	200μA Supply Current, Narrow 16-Pin SO
LTC2844	3.3V, Software-Selectable Multiprotocol Transceiver	4 Drivers, 4 Receivers for Control Signals Including LL
LTC2845	3.3V, Software-Selectable Multiprotocol Transceiver	5 Drivers, 5 Receivers for Control Signals Including LL, RL and TM
LTC2846	3.3V, Software-Selectable Multiprotocol Transceiver	4 Drivers, 4 Receivers with Termination for Data/Clock